

2SD2213

Silicon NPN Epitaxial, Darlington

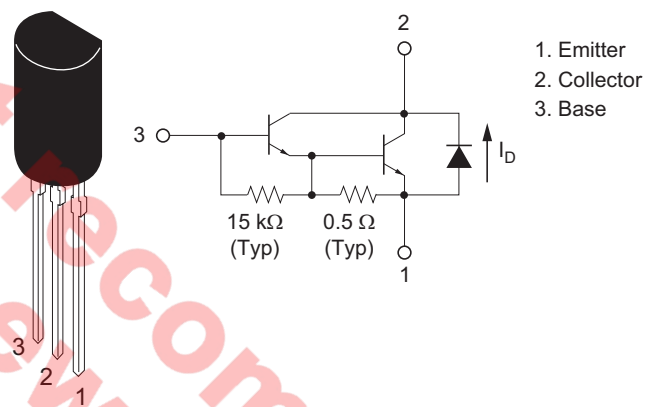
REJ03G0807-0200
(Previous ADE-208-1165)
Rev.2.00
Aug.10.2005

Application

Low frequency power amplifier

Outline

RENESAS Package code: PRSS0003DC-A
(Package name: TO-92 Mod)



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	150	V
Collector to emitter voltage	V_{CEO}	80	V
Emitter to base voltage	V_{EBO}	8	V
Collector current	I_C	1.5	A
Collector peak current	$i_{c (peak)}$	3	A
Collector power dissipation	P_C	0.9	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C
E to C diode forward current	I_D	1.5	A

Electrical Characteristics

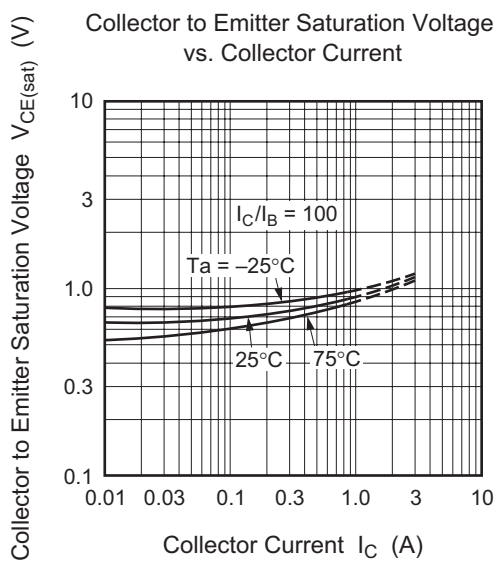
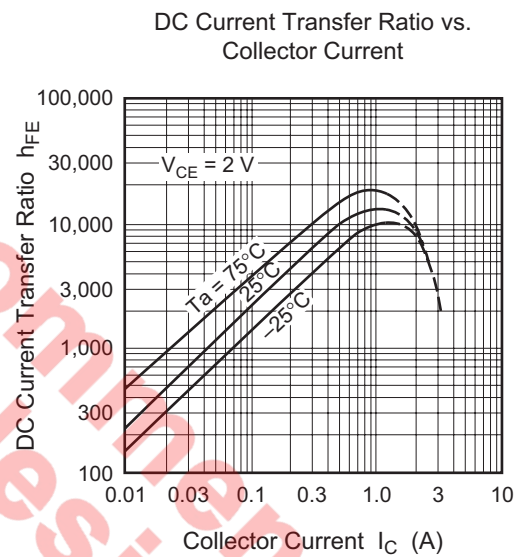
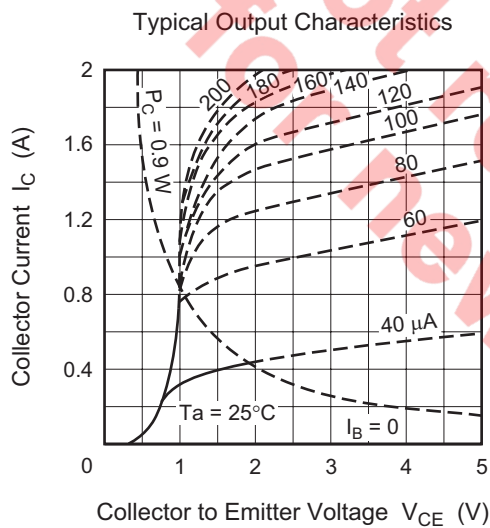
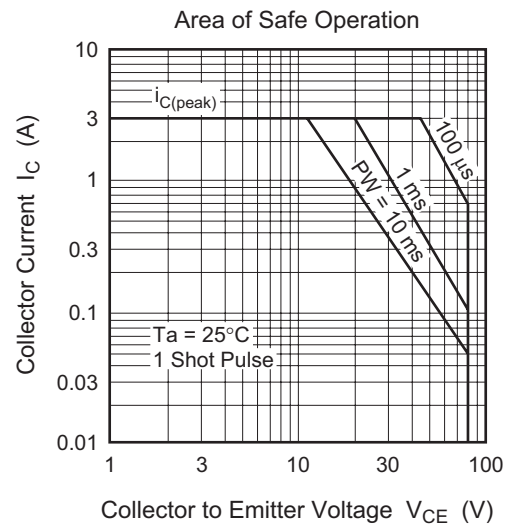
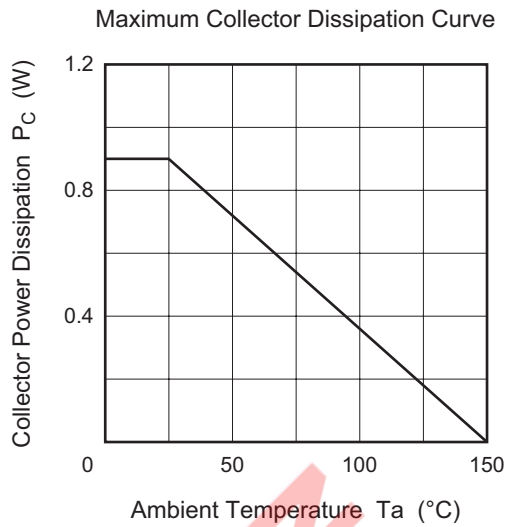
(Ta = 25°C)

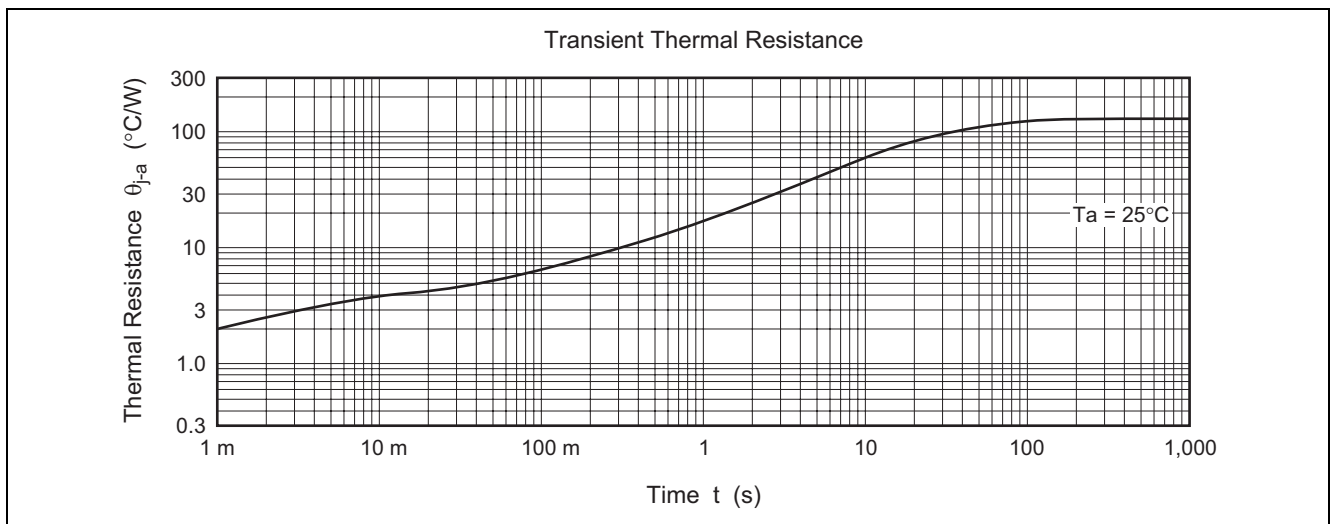
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	150	—	—	V	$I_C = 1 \text{ mA}$, $I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	80	—	—	V	$I_C = 10 \text{ mA}$, $R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	8	—	—	V	$I_E = 50 \text{ mA}$, $I_C = 0$
Collector cutoff current	I_{CBO}	—	—	5.0	μA	$V_{CB} = 120 \text{ V}$, $I_E = 0$
	I_{CEO}	—	—	5.0	μA	$V_{CE} = 65 \text{ V}$, $I_E = \infty$
DC current transfer ratio	h_{FE}	2000	—	—		$V_{CE} = 2 \text{ V}$, $I_C = 0.15 \text{ A}^{*1}$
	h_{FE}	5000	—	30000		$V_{CE} = 2 \text{ V}$, $I_C = 1 \text{ A}^{*1}$
	h_{FE}	1000	—	—		$V_{CE} = 2 \text{ V}$, $I_C = 1.5 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	1.5	V	$I_C = 1 \text{ A}^{*1}$, $I_B = 1 \text{ mA}$
Base to emitter saturation voltage	$V_{BE(sat)}$	—	—	2.0	V	$I_C = 1 \text{ A}^{*1}$, $I_B = 1 \text{ mA}$
E to C diode forward voltage	V_D	—	—	3.0	V	$I_D = 1.5 \text{ A}^{*1}$

Note: 1. Pulse test

Not recommend
for new design

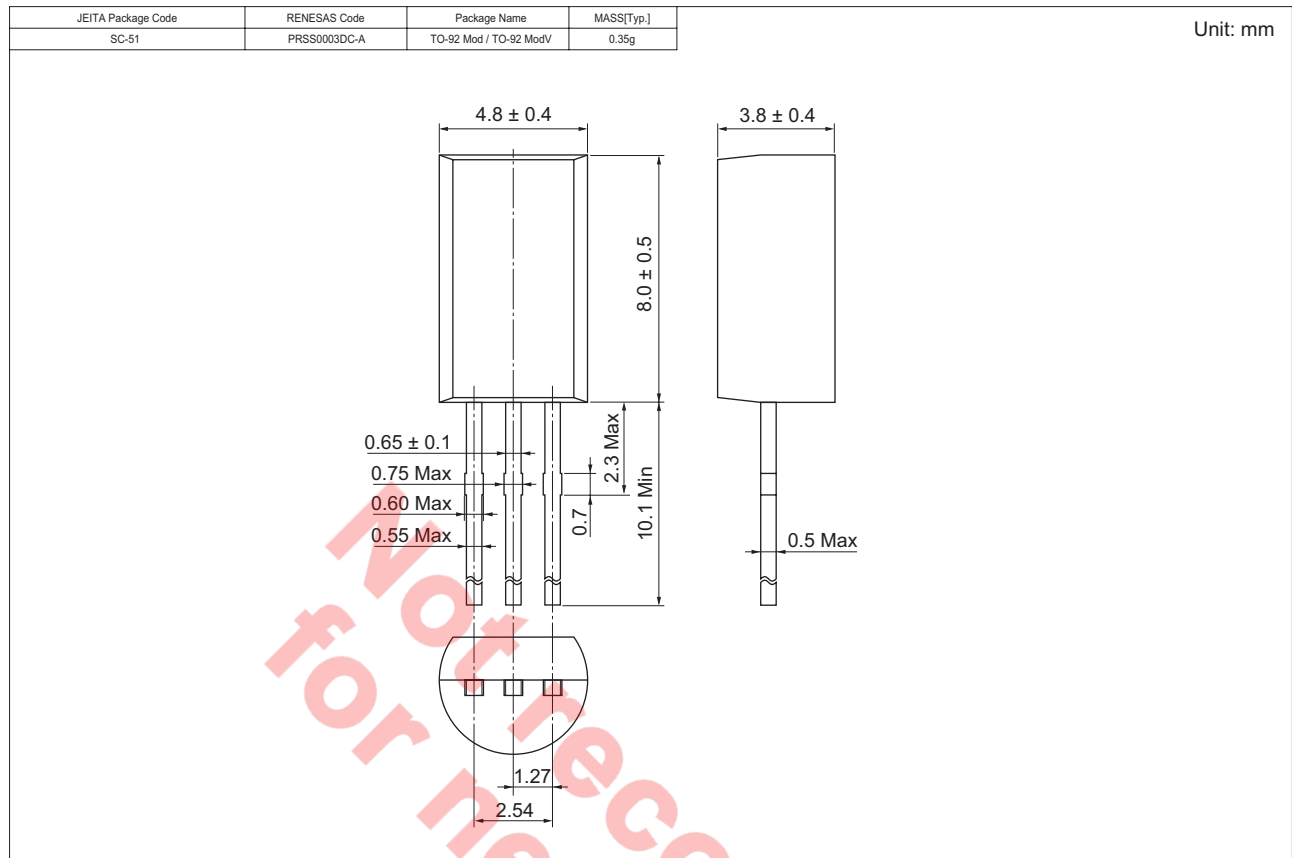
Main Characteristics





Not recommend
for new design

Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SD2213TZ	2500	Hold Box, Radial Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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